

# EVVOSEMI<sup>®</sup>

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

## Product Specification

▶ Domestic	Part Number	MB1S THRU MB10S
▶ Overseas	Part Number	MB1S THRU MB10S
▶ Equivalent	Part Number	MB1S THRU MB10S

EV is the abbreviation of name EVVO

**FEATURES:**

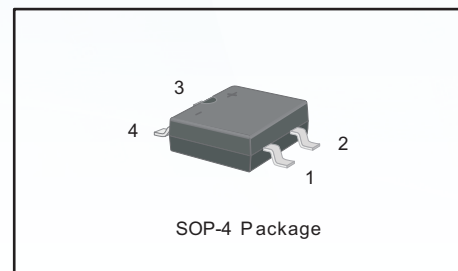
Glass Passivated Chip Junction  
 Reverse Voltage - 100 to 1000 V  
 Forward Current - 0.8A  
 High Surge Current Capability  
 Designed for Surface Mount Application

**MECHANICAL DATA**

- Case: SOP-4
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 100mg / 0.0035oz

**PINNING**

PIN	DESCRIPTION
1	Input Pin ( ~ )
2	Input Pin ( ~ )
3	Output Anode ( + )
4	Output Cathode ( - )

**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	100	200	400	600	800	1000	V
Average Rectified Output Current at $T_c = 125\text{ }^{\circ}\text{C}$	$I_O$	0.8						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	35						A
Maximum Forward Voltage at 1.0 A	$V_F$	1.1						V
Maximum DC Reverse Current @ $T_A = 25\text{ }^{\circ}\text{C}$ at Rated DC Blocking Voltage @ $T_A = 125\text{ }^{\circ}\text{C}$	$I_R$	5 40						$\mu\text{A}$
Typical Junction Capacitance ( Note1 )	$C_j$	13						pF
Typical Thermal Resistance ( Note2 )	$R_{\theta JA}$ $R_{\theta JC}$	80 28						$^{\circ}\text{C/W}$
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150						$^{\circ}\text{C}$

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×1.5"×1.5" ( 3.81×3.81 cm ) copper pad.

Fig.1 Average Rectified Output Current Derating Curve

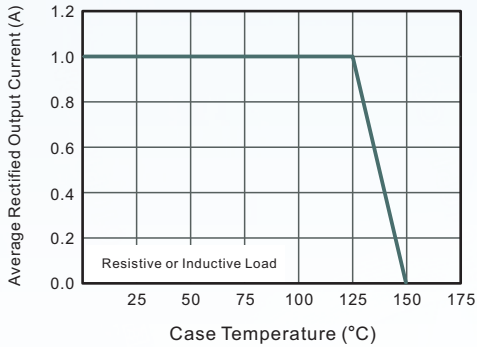


Fig.2 Typical Reverse Characteristics

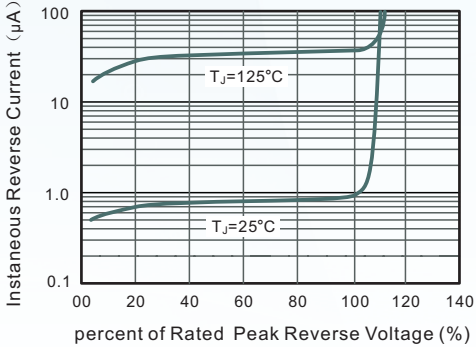


Fig.3 Typical Instantaneous Forward Characteristics

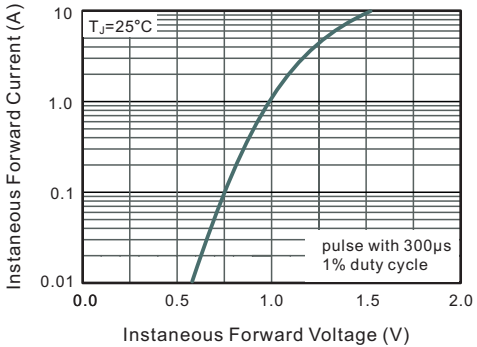


Fig.4 Typical Junction Capacitance

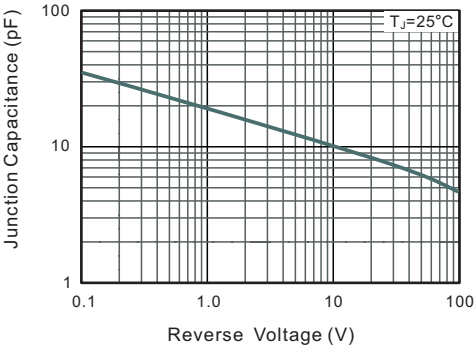
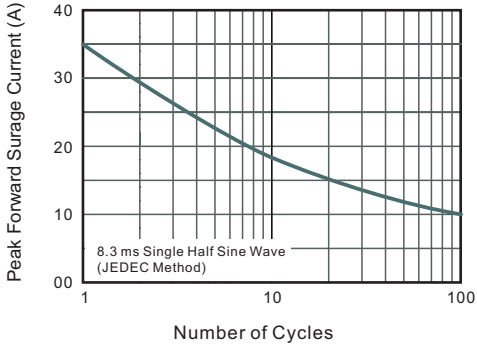
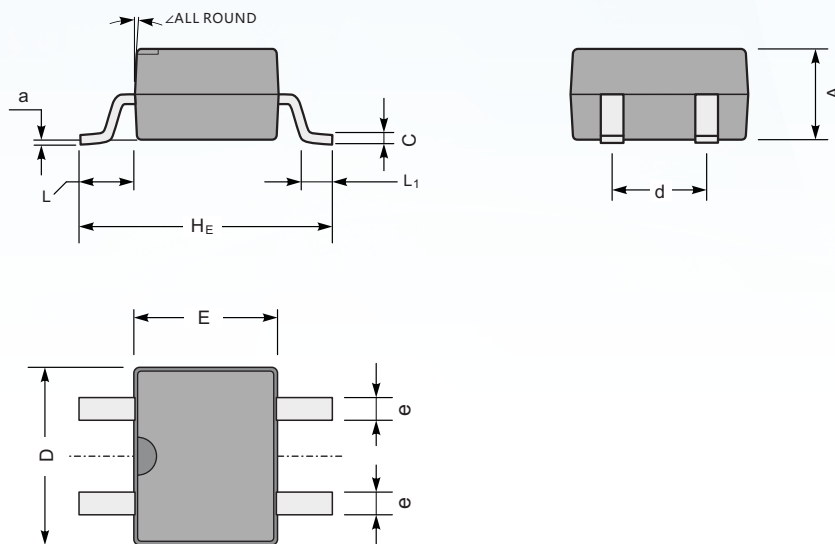


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



## PACKAGE OUTLINE

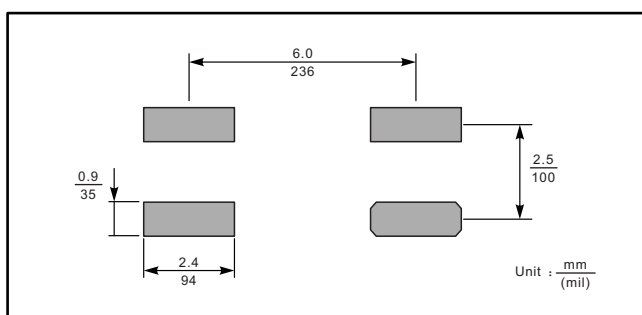
Plastic surface mounted package; 4 leads



SOP-4 mechanical data

UNIT		A	C	D	E	$H_E$	d	e	L	$L_1$	a	$\angle$
mm	max	2.6	0.22	5.0	4.1	7.0	2.7	0.7	1.7	1.1	0.2	7°
	min	2.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5	—	
mil	max	102	8.7	197	161	276	106	28	67	43	8	
	min	94	5.9	177	142	252	91	20	51	20	—	

### The recommended mounting pad size



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